

## Description

The 9DBU0631 is a member of Renesas' 1.5V Ultra-Low-Power (ULP) PCIe family. The device has 6 output enables for clock management and 3 selectable SMBus addresses.

## Recommended Application

1.5V PCIe Gen1-2-3 Zero-Delay/Fan-out Buffer (ZDB/FOB)

## Output Features

- 6 – 1-167MHz Low-Power (LP) HCSL DIF pairs

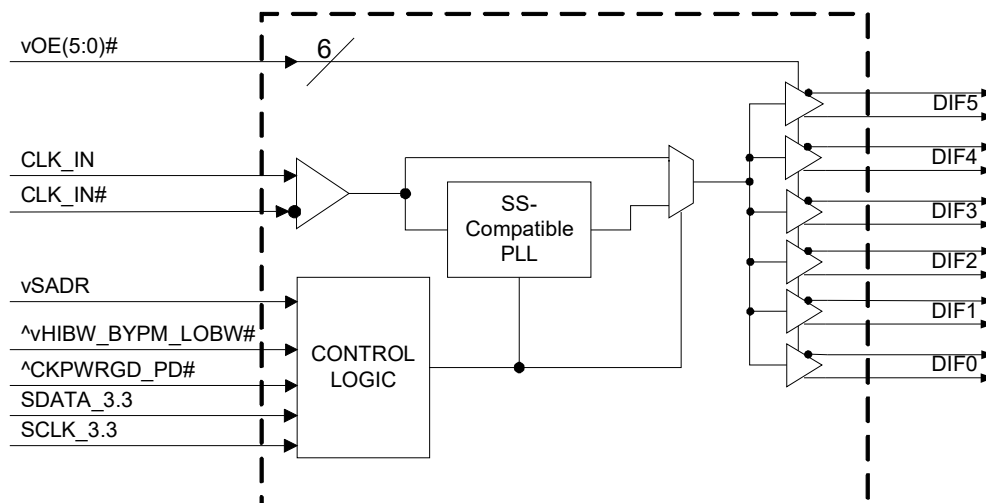
## Key Specifications

- DIF cycle-to-cycle jitter < 50ps
- DIF output-to-output skew < 60ps
- DIF phase jitter is PCIe Gen1-2-3 compliant
- DIF bypass mode *additive* phase jitter is < 300fs RMS for PCIe Gen3
- DIF bypass mode *additive* phase jitter < 350fs RMS for 12kHz–20MHz

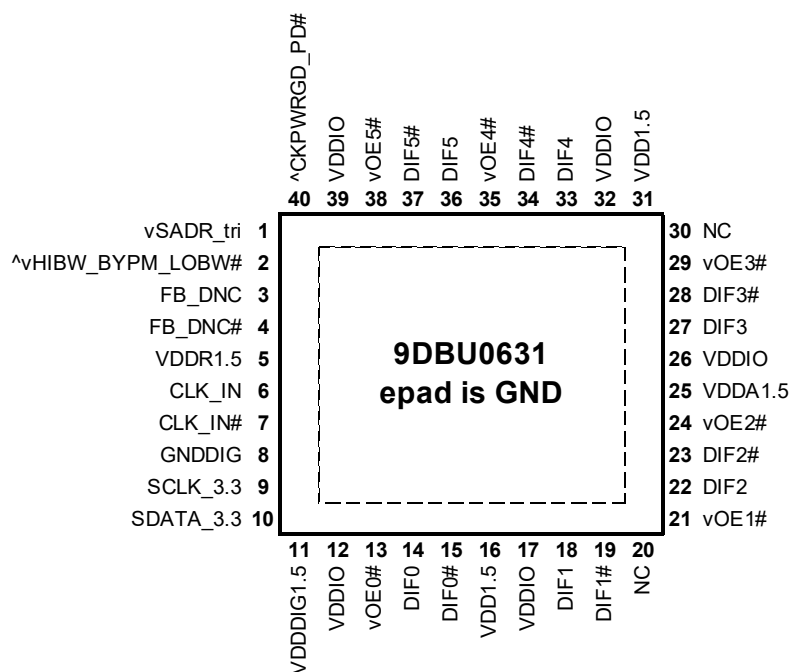
## Features/Benefits

- LP-HCSL outputs; save 12 resistors compared to standard HCSL outputs
- 46mW typical power consumption in PLL mode; eliminates thermal concerns
- Outputs can optionally be supplied from any voltage between 1.05 and 1.5V; maximum power savings
- Spread Spectrum (SS) compatible; allows SS for EMI reduction
- OE# pins; support DIF power management
- HCSL-compatible differential input; can be driven by common clock sources
- SMBus-selectable features; optimize signal integrity to application:
  - Slew rate for each output
  - Differential output amplitude
- Pin/SMBus selectable PLL bandwidth and PLL Bypass; optimize PLL to application
- Outputs blocked until PLL is locked; clean system start-up
- Device contains default configuration; SMBus interface not required for device control
- 3.3V tolerant SMBus interface works with legacy controllers
- Three selectable SMBus addresses; multiple devices can easily share an SMBus segment
- Space saving 40-pin 5 x 5 mm VFQFPN; minimal board space

## Block Diagram



# Pin Configuration



40-VFQFPN, 5mm x 5mm 0.4mm pin pitch

^ prefix indicates internal 120KOhm pull up resistor

^v prefix indicates internal 120KOhm pull up AND pull down resistor (biased to VDD/2)

v prefix indicates internal 120KOhm pull down resistor

## SMBus Address Selection Table

|                                                   | SADR | Address | + Read/Write bit |
|---------------------------------------------------|------|---------|------------------|
| State of SADR on first application of CKPWRGD_PD# | 0    | 1101011 | x                |
|                                                   | M    | 1101100 | x                |
|                                                   | 1    | 1101101 | x                |

## Power Management Table

| CKPWRGD_PD# | CLK_IN  | SMBus<br>OEx bit | OEx# Pin | DIFx     |           | PLL             |
|-------------|---------|------------------|----------|----------|-----------|-----------------|
|             |         |                  |          | True O/P | Comp. O/P |                 |
| 0           | X       | X                | X        | Low      | Low       | Off             |
| 1           | Running | 0                | X        | Low      | Low       | On <sup>1</sup> |
| 1           | Running | 1                | 0        | Running  | Running   | On <sup>1</sup> |
| 1           | Running | 1                | 1        | Low      | Low       | On <sup>1</sup> |

1. If Bypass mode is selected, the PLL will be off, and outputs will follow this table.

## Power Connections

| Pin Number |                | GND | Description           |
|------------|----------------|-----|-----------------------|
| VDD        | VDDIO          |     |                       |
| 5          |                | 41  | Input receiver analog |
| 11         |                | 8   | Digital Power         |
| 16,31      | 12,17,26,32,39 | 41  | DIF outputs, Logic    |
| 25         |                | 41  | PLL Analog            |

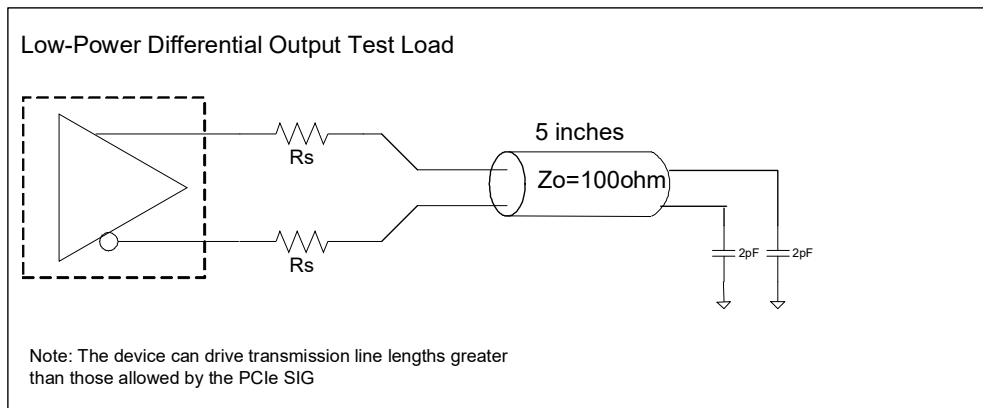
## PLL Operating Mode

| HiBW_BypM_LoBW# | MODE      | Byte1 [7:6]<br>Readback | Byte1 [4:3]<br>Control |
|-----------------|-----------|-------------------------|------------------------|
| 0               | PLL Lo BW | 00                      | 00                     |
| M               | Bypass    | 01                      | 01                     |
| 1               | PLL Hi BW | 11                      | 11                     |

# Pin Descriptions

| PIN # | PIN NAME          | PIN TYPE   | DESCRIPTION                                                                                                                                                                                               |
|-------|-------------------|------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1     | vSADR_tri         | LATCHED IN | Tri-level latch to select SMBus Address. See SMBus Address Selection Table.                                                                                                                               |
| 2     | ^vHIBW_BYPM_LOBW# | LATCHED IN | Trilevel input to select High BW, Bypass or Low BW mode. See PLL Operating Mode Table for Details.                                                                                                        |
| 3     | FB_DNC            | DNC        | True clock of differential feedback. The feedback output and feedback input are connected internally on this pin. Do not connect anything to this pin.                                                    |
| 4     | FB_DNC#           | DNC        | Complement clock of differential feedback. The feedback output and feedback input are connected internally on this pin. Do not connect anything to this pin.                                              |
| 5     | VDDR1.5           | PWR        | 1.5V power for differential input clock (receiver). This VDD should be treated as an Analog power rail and filtered appropriately.                                                                        |
| 6     | CLK_IN            | IN         | True Input for differential reference clock.                                                                                                                                                              |
| 7     | CLK_IN#           | IN         | Complementary Input for differential reference clock.                                                                                                                                                     |
| 8     | GNDDIG            | GND        | Ground pin for digital circuitry                                                                                                                                                                          |
| 9     | SCLK_3.3          | IN         | Clock pin of SMBus circuitry, 3.3V tolerant.                                                                                                                                                              |
| 10    | SDATA_3.3         | I/O        | Data pin for SMBus circuitry, 3.3V tolerant.                                                                                                                                                              |
| 11    | VDDDIG1.5         | PWR        | 1.5V digital power (dirty power)                                                                                                                                                                          |
| 12    | VDDIO             | PWR        | Power supply for differential outputs                                                                                                                                                                     |
| 13    | vOE0#             | IN         | Active low input for enabling DIF pair 0. This pin has an internal pull-down.<br>1 =disable outputs, 0 = enable outputs                                                                                   |
| 14    | DIF0              | OUT        | Differential true clock output                                                                                                                                                                            |
| 15    | DIF0#             | OUT        | Differential Complementary clock output                                                                                                                                                                   |
| 16    | VDD1.5            | PWR        | Power supply, nominally 1.5V                                                                                                                                                                              |
| 17    | VDDIO             | PWR        | Power supply for differential outputs                                                                                                                                                                     |
| 18    | DIF1              | OUT        | Differential true clock output                                                                                                                                                                            |
| 19    | DIF1#             | OUT        | Differential Complementary clock output                                                                                                                                                                   |
| 20    | NC                | N/A        | No Connection.                                                                                                                                                                                            |
| 21    | vOE1#             | IN         | Active low input for enabling DIF pair 1. This pin has an internal pull-down.<br>1 =disable outputs, 0 = enable outputs                                                                                   |
| 22    | DIF2              | OUT        | Differential true clock output                                                                                                                                                                            |
| 23    | DIF2#             | OUT        | Differential Complementary clock output                                                                                                                                                                   |
| 24    | vOE2#             | IN         | Active low input for enabling DIF pair 2. This pin has an internal pull-down.<br>1 =disable outputs, 0 = enable outputs                                                                                   |
| 25    | VDDA1.5           | PWR        | 1.5V power for the PLL core.                                                                                                                                                                              |
| 26    | VDDIO             | PWR        | Power supply for differential outputs                                                                                                                                                                     |
| 27    | DIF3              | OUT        | Differential true clock output                                                                                                                                                                            |
| 28    | DIF3#             | OUT        | Differential Complementary clock output                                                                                                                                                                   |
| 29    | vOE3#             | IN         | Active low input for enabling DIF pair 3. This pin has an internal pull-down.<br>1 =disable outputs, 0 = enable outputs                                                                                   |
| 30    | NC                | N/A        | No Connection.                                                                                                                                                                                            |
| 31    | VDD1.5            | PWR        | Power supply, nominally 1.5V                                                                                                                                                                              |
| 32    | VDDIO             | PWR        | Power supply for differential outputs                                                                                                                                                                     |
| 33    | DIF4              | OUT        | Differential true clock output                                                                                                                                                                            |
| 34    | DIF4#             | OUT        | Differential Complementary clock output                                                                                                                                                                   |
| 35    | vOE4#             | IN         | Active low input for enabling DIF pair 4. This pin has an internal pull-down.<br>1 =disable outputs, 0 = enable outputs                                                                                   |
| 36    | DIF5              | OUT        | Differential true clock output                                                                                                                                                                            |
| 37    | DIF5#             | OUT        | Differential Complementary clock output                                                                                                                                                                   |
| 38    | vOE5#             | IN         | Active low input for enabling DIF pair 5. This pin has an internal pull-down.<br>1 =disable outputs, 0 = enable outputs                                                                                   |
| 39    | VDDIO             | PWR        | Power supply for differential outputs                                                                                                                                                                     |
| 40    | ^CKPWRGD_PD#      | IN         | Input notifies device to sample latched inputs and start up on first high assertion. Low enters Power Down Mode, subsequent high assertions exit Power Down Mode. This pin has internal pull-up resistor. |
| 41    | ePAD              | GND        | Connect paddle to ground.                                                                                                                                                                                 |

## Test Loads



### Alternate Differential Output Terminations

| Rs | Zo  | Units |
|----|-----|-------|
| 33 | 100 | Ohms  |
| 27 | 85  |       |

## Alternate Terminations

The output can easily drive other logic families. See “[AN-891 Driving LVPECL, LVDS, CML, and SSTL Logic with Universal Low-Power HCSL Outputs](#)” for LVPECL, LVDS, CML, and SSTL.

## Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the 9DBU0631. These ratings, which are standard values for Renesas commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

| PARAMETER                 | SYMBOL             | CONDITIONS                | MIN  | TYP | MAX                  | UNITS | NOTES |
|---------------------------|--------------------|---------------------------|------|-----|----------------------|-------|-------|
| Supply Voltage            | VDDx               |                           | -0.5 |     | 2                    | V     | 1,2   |
| Input Voltage             | V <sub>IN</sub>    |                           | -0.5 |     | V <sub>DD</sub> +0.5 | V     | 1,3   |
| Input High Voltage, SMBus | V <sub>IHSMB</sub> | SMBus clock and data pins |      |     | 3.3                  | V     | 1     |
| Storage Temperature       | T <sub>s</sub>     |                           | -65  |     | 150                  | °C    | 1     |
| Junction Temperature      | T <sub>j</sub>     |                           |      |     | 125                  | °C    | 1     |
| Input ESD protection      | ESD prot           | Human Body Model          | 2000 |     |                      | V     | 1     |

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup>Operation under these conditions is neither implied nor guaranteed.

<sup>3</sup>Not to exceed 2.0V.

## Electrical Characteristics—Clock Input Parameters

T<sub>A</sub> = T<sub>AMB</sub>, Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER                          | SYMBOL             | CONDITIONS                                                | MIN | TYP | MAX  | UNITS | NOTES |
|------------------------------------|--------------------|-----------------------------------------------------------|-----|-----|------|-------|-------|
| Input Common Mode Voltage - DIF_IN | V <sub>COM</sub>   | Common Mode Input Voltage                                 | 200 |     | 725  | mV    | 1     |
| Input Swing - DIF_IN               | V <sub>SWING</sub> | Differential value                                        | 300 |     | 1450 | mV    | 1     |
| Input Slew Rate - DIF_IN           | dv/dt              | Measured differentially                                   | 0.4 |     | 8    | V/ns  | 1,2   |
| Input Leakage Current              | I <sub>IN</sub>    | V <sub>IN</sub> = V <sub>DD</sub> , V <sub>IN</sub> = GND | -5  |     | 5    | uA    |       |
| Input Duty Cycle                   | d <sub>tin</sub>   | Measurement from differential waveform                    | 45  | 50  | 55   | %     | 1     |
| Input Jitter - Cycle to Cycle      | J <sub>DIFIn</sub> | Differential Measurement                                  | 0   |     | 150  | ps    | 1     |

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup>Slew rate measured through +/-75mV window centered around differential zero

# Electrical Characteristics–Input/Supply/Common Parameters–Normal Operating Conditions

TA = T<sub>AMB</sub>; Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER                              | SYMBOL                 | CONDITIONS                                                                                                                                              | MIN                  | TYP    | MAX                   | UNITS  | NOTES |
|----------------------------------------|------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------|--------|-----------------------|--------|-------|
| Supply Voltage                         | VDDx                   | Supply voltage for core and analog                                                                                                                      | 1.425                | 1.5    | 1.575                 | V      |       |
| Output Supply Voltage                  | VDDIO                  | Supply voltage for Low Power HCSL Outputs                                                                                                               | 0.95                 | 1.05   | 1.575                 | V      |       |
| Ambient Operating Temperature          | T <sub>AMB</sub>       | Commercial range                                                                                                                                        | 0                    | 25     | 70                    | °C     | 1     |
|                                        |                        | Industrial range                                                                                                                                        | -40                  | 25     | 85                    | °C     | 1     |
| Input High Voltage                     | V <sub>IH</sub>        | Single-ended inputs, except SMBus                                                                                                                       | 0.75 V <sub>DD</sub> |        | V <sub>DD</sub> + 0.3 | V      |       |
| Input Mid Voltage                      | V <sub>IM</sub>        | Single-ended tri-level inputs ('_tri' suffix)                                                                                                           | 0.4 V <sub>DD</sub>  |        | 0.6 V <sub>DD</sub>   | V      |       |
| Input Low Voltage                      | V <sub>IL</sub>        | Single-ended inputs, except SMBus                                                                                                                       | -0.3                 |        | 0.25 V <sub>DD</sub>  | V      |       |
| Input Current                          | I <sub>IN</sub>        | Single-ended inputs, V <sub>IN</sub> = GND, V <sub>IN</sub> = VDD                                                                                       | -5                   |        | 5                     | uA     |       |
|                                        | I <sub>INP</sub>       | Single-ended inputs<br>V <sub>IN</sub> = 0 V; Inputs with internal pull-up resistors<br>V <sub>IN</sub> = VDD; Inputs with internal pull-down resistors | -200                 |        | 200                   | uA     |       |
| Input Frequency                        | F <sub>ibyp</sub>      | Bypass mode                                                                                                                                             | 1                    |        | 167                   | MHz    | 2     |
|                                        | F <sub>ipll</sub>      | 100MHz PLL mode                                                                                                                                         | 20                   | 100.00 | 110                   | MHz    | 2     |
| Pin Inductance                         | L <sub>pin</sub>       |                                                                                                                                                         |                      |        | 7                     | nH     | 1     |
| Capacitance                            | C <sub>IN</sub>        | Logic Inputs, except DIF_IN                                                                                                                             | 1.5                  |        | 5                     | pF     | 1     |
|                                        | C <sub>INDIF_IN</sub>  | DIF_IN differential clock inputs                                                                                                                        | 1.5                  |        | 2.7                   | pF     | 1,5   |
|                                        | C <sub>OUT</sub>       | Output pin capacitance                                                                                                                                  |                      |        | 6                     | pF     | 1     |
| Clk Stabilization                      | T <sub>STAB</sub>      | From V <sub>DD</sub> Power-Up and after input clock stabilization or de-assertion of PD# to 1st clock                                                   |                      |        | 1                     | ms     | 1,2   |
| Input SS Modulation Frequency PCIe     | f <sub>MODINPCIe</sub> | Allowable Frequency for PCIe Applications (Triangular Modulation)                                                                                       | 30                   |        | 33                    | kHz    |       |
| Input SS Modulation Frequency non-PCIe | f <sub>MODIN</sub>     | Allowable Frequency for non-PCIe Applications (Triangular Modulation)                                                                                   | 0                    |        | 66                    | kHz    |       |
| OE# Latency                            | t <sub>LATOE#</sub>    | DIF start after OE# assertion<br>DIF stop after OE# deassertion                                                                                         | 1                    |        | 3                     | clocks | 1,3   |
| Tdrive_PD#                             | t <sub>DRVPD</sub>     | DIF output enable after PD# de-assertion                                                                                                                |                      |        | 300                   | us     | 1,3   |
| Tfall                                  | t <sub>F</sub>         | Fall time of single-ended control inputs                                                                                                                |                      |        | 5                     | ns     | 2     |
| Trise                                  | t <sub>R</sub>         | Rise time of single-ended control inputs                                                                                                                |                      |        | 5                     | ns     | 2     |
| SMBus Input Low Voltage                | V <sub>ILSMB</sub>     |                                                                                                                                                         |                      |        | 0.6                   | V      |       |
| SMBus Input High Voltage               | V <sub>IHSMB</sub>     | V <sub>DDSMB</sub> = 3.3V, see note 4 for V <sub>DDSMB</sub> < 3.3V                                                                                     | 2.1                  |        | 3.3                   | V      | 4     |
| SMBus Output Low Voltage               | V <sub>OLSMB</sub>     | @ I <sub>PULLUP</sub>                                                                                                                                   |                      |        | 0.4                   | V      |       |
| SMBus Sink Current                     | I <sub>PULLUP</sub>    | @ V <sub>OL</sub>                                                                                                                                       | 4                    |        |                       | mA     |       |
| Nominal Bus Voltage                    | V <sub>DDSMB</sub>     | Bus Voltage                                                                                                                                             | 1.425                |        | 3.3                   | V      |       |
| SCLK/SDATA Rise Time                   | t <sub>RSMB</sub>      | (Max V <sub>IL</sub> - 0.15) to (Min V <sub>IH</sub> + 0.15)                                                                                            |                      |        | 1000                  | ns     | 1     |
| SCLK/SDATA Fall Time                   | t <sub>FSMB</sub>      | (Min V <sub>IH</sub> + 0.15) to (Max V <sub>IL</sub> - 0.15)                                                                                            |                      |        | 300                   | ns     | 1     |
| SMBus Operating Frequency              | f <sub>MAXSMB</sub>    | Maximum SMBus operating frequency                                                                                                                       |                      |        | 400                   | kHz    | 6     |

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup>Control input must be monotonic from 20% to 80% of input swing.

<sup>3</sup>Time from deassertion until outputs are >200 mV

<sup>4</sup>For V<sub>DDSMB</sub> < 3.3V, V<sub>IHSMB</sub> >= 0.8xV<sub>DDSMB</sub>

<sup>5</sup>DIF\_IN input

<sup>6</sup>The differential input clock must be running for the SMBus to be active

## Electrical Characteristics–DIF Low-Power HCSL Outputs

TA = T<sub>AMB</sub>; Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER              | SYMBOL                       | CONDITIONS                                                                                            | MIN  | TYP  | MAX  | UNITS | NOTES |
|------------------------|------------------------------|-------------------------------------------------------------------------------------------------------|------|------|------|-------|-------|
| Slew rate              | dV/dt                        | Scope averaging on, fast setting                                                                      | 1.4  | 2.2  | 3.5  | V/ns  | 1,2,3 |
|                        | dV/dt                        | Scope averaging on, slow setting                                                                      | 0.9  | 1.7  | 2.5  | V/ns  | 1,2,3 |
| Slew rate matching     | $\Delta$ dV/dt               | Slew rate matching, Scope averaging on                                                                |      | 2.7  | 20   | %     | 1,2,4 |
| Voltage High           | V <sub>HIGH</sub>            | Statistical measurement on single-ended signal using oscilloscope math function. (Scope averaging on) | 630  | 735  | 850  | mV    | 7     |
| Voltage Low            | V <sub>LOW</sub>             |                                                                                                       | -150 | -16  | 150  |       | 7     |
| Max Voltage            | V <sub>max</sub>             | Measurement on single ended signal using absolute value. (Scope averaging off)                        |      | 779  | 1150 | mV    | 7     |
| Min Voltage            | V <sub>min</sub>             |                                                                                                       | -300 | -45  |      |       | 7     |
| Vswing                 | Vswing                       | Scope averaging off                                                                                   | 300  | 1503 |      | mV    | 1,2   |
| Crossing Voltage (abs) | V <sub>cross_abs</sub>       | Scope averaging off                                                                                   | 250  | 405  | 550  | mV    | 1,5   |
| Crossing Voltage (var) | $\Delta$ -V <sub>cross</sub> | Scope averaging off                                                                                   |      | 12   | 140  | mV    | 1,6   |

<sup>1</sup>Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Measured from differential waveform

<sup>3</sup> Slew rate is measured through the Vswing voltage range centered around differential 0V. This results in a +/-150mV window around differential 0V.

<sup>4</sup> Matching applies to rising edge rate for Clock and falling edge rate for Clock#. It is measured using a +/-75mV window centered on the average cross point where Clock rising meets Clock# falling. The median cross point is used to calculate the voltage thresholds the oscilloscope is to use for the edge rate calculations.

<sup>5</sup> V<sub>cross</sub> is defined as voltage where Clock = Clock# measured on a component test board and only applies to the differential rising edge (i.e. Clock rising and Clock# falling).

<sup>6</sup> The total variation of all V<sub>cross</sub> measurements in any particular system. Note that this is a subset of V<sub>cross\_min/max</sub> (V<sub>cross</sub> absolute) allowed. The intent is to limit V<sub>cross</sub> induced modulation by setting  $\Delta$ -V<sub>cross</sub> to be smaller than V<sub>cross</sub> absolute.

<sup>7</sup> At default SMBus settings.

## Electrical Characteristics–Current Consumption

TA = T<sub>AMB</sub>; Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER                | SYMBOL             | CONDITIONS                        | MIN | TYP    | MAX  | UNITS | NOTES |
|--------------------------|--------------------|-----------------------------------|-----|--------|------|-------|-------|
| Operating Supply Current | I <sub>DDA</sub>   | VDDA+VDDR, PLL Mode, @100MHz      |     | 10     | 15   | mA    | 1     |
|                          | I <sub>DDx</sub>   | VDDx, All outputs active @100MHz  |     | 5      | 8    | mA    | 1     |
|                          | I <sub>DDO</sub>   | VDDIO, All outputs active @100MHz |     | 21     | 30   | mA    | 1     |
| Powerdown Current        | I <sub>DDAPD</sub> | VDDA+VDDR, PLL Mode, @100MHz      |     | 0.4    | 1    | mA    | 1, 2  |
|                          | I <sub>DDPDx</sub> | VDDx, Outputs Low/Low             |     | 0.25   | 0.5  | mA    | 1, 2  |
|                          | I <sub>DDOPD</sub> | VDDIO, Outputs Low/Low            |     | 0.0003 | 0.01 | mA    | 1, 2  |

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Input clock stopped.

## Electrical Characteristics—Output Duty Cycle, Jitter, Skew and PLL Characteristics

TA = T<sub>AMB</sub>; Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER              | SYMBOL               | CONDITIONS                                   | MIN  | TYP  | MAX  | UNITS | NOTES |
|------------------------|----------------------|----------------------------------------------|------|------|------|-------|-------|
| PLL Bandwidth          | BW                   | -3dB point in High BW Mode (100MHz)          | 2.2  | 3.6  | 4.8  | MHz   | 1,5   |
|                        |                      | -3dB point in Low BW Mode (100MHz)           | 1    | 1.6  | 2.5  | MHz   | 1,5   |
| PLL Jitter Peaking     | t <sub>JPEAK</sub>   | Peak Pass band Gain (100MHz)                 |      | 1.3  | 2.5  | dB    | 1     |
| Duty Cycle             | t <sub>DC</sub>      | Measured differentially, PLL Mode            | 45   | 50.2 | 55   | %     | 1     |
| Duty Cycle Distortion  | t <sub>DCD</sub>     | Measured differentially, Bypass Mode @100MHz | -1   | -0.6 | 0    | %     | 1,3   |
| Skew, Input to Output  | t <sub>pdBYP</sub>   | Bypass Mode, V <sub>T</sub> = 50%            | 3400 | 4300 | 5200 | ps    | 1     |
|                        | t <sub>pdPLL</sub>   | PLL Mode V <sub>T</sub> = 50%                | 0    | 50   | 200  | ps    | 1,4   |
| Skew, Output to Output | t <sub>sk3</sub>     | V <sub>T</sub> = 50%                         |      | 37   | 75   | ps    | 1,4   |
| Jitter, Cycle to cycle | t <sub>jcc-cyc</sub> | PLL mode                                     |      | 24   | 50   | ps    | 1,2   |
|                        |                      | Additive Jitter in Bypass Mode               |      | 0.1  | 5    | ps    | 1,2   |

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> Measured from differential waveform

<sup>3</sup> Duty cycle distortion is the difference in duty cycle between the output and the input clock when the device is operated in bypass mode.

<sup>4</sup> All outputs at default slew rate

<sup>5</sup> The MIN/TYP/MAX values of each BW setting track each other, i.e., Low BW MAX will never occur with Hi BW MIN.

## Electrical Characteristics—Phase Jitter Parameters

TA = T<sub>AMB</sub>; Supply Voltages per normal operation conditions, See Test Loads for Loading Conditions

| PARAMETER                          | SYMBOL                     | CONDITIONS                                                                               | MIN | TYP | MAX | INDUSTRY LIMIT | UNITS    | Notes     |
|------------------------------------|----------------------------|------------------------------------------------------------------------------------------|-----|-----|-----|----------------|----------|-----------|
| Phase Jitter, PLL Mode             | t <sub>jphPCleG1</sub>     | PCle Gen 1                                                                               |     | 30  | 58  | 86             | ps (p-p) | 1,2,3,5   |
|                                    | t <sub>jphPCleG2</sub>     | PCle Gen 2 Lo Band<br>10kHz < f < 1.5MHz                                                 |     | 0.9 | 1.4 | 3              | ps (rms) | 1,2,3,5   |
|                                    |                            | PCle Gen 2 High Band<br>1.5MHz < f < Nyquist (50MHz)                                     |     | 2.1 | 2.6 | 3.1            | ps (rms) | 1,2,3,5   |
|                                    | t <sub>jphPCleG3</sub>     | PCle Gen 3 Common Clock Architecture<br>(PLL BW of 2-4 or 2-5MHz, CDR = 10MHz)           |     | 0.5 | 0.6 | 1              | ps (rms) | 1,2,3,5   |
|                                    | t <sub>jphPCleG3SRns</sub> | PCle Gen 3 Separate Reference No Spread (SRns)<br>(PLL BW of 2-4 or 2-5MHz, CDR = 10MHz) |     | 0.5 | 0.6 | 0.7            | ps (rms) | 1,2,3,5   |
| Additive Phase Jitter, Bypass Mode | t <sub>jphPCleG1</sub>     | PCle Gen 1                                                                               |     | 0.1 | 5   | N/A            | ps (p-p) | 1,2,3,5   |
|                                    | t <sub>jphPCleG2</sub>     | PCle Gen 2 Lo Band<br>10kHz < f < 1.5MHz                                                 |     | 0.1 | 0.5 | N/A            | ps (rms) | 1,2,3,4,5 |
|                                    |                            | PCle Gen 2 High Band<br>1.5MHz < f < Nyquist (50MHz)                                     |     | 0.1 | 0.3 | N/A            | ps (rms) | 1,2,3,4   |
|                                    | t <sub>jphPCleG3</sub>     | PCle Gen 3<br>(PLL BW of 2-4 or 2-5MHz, CDR = 10MHz)                                     |     | 0.2 | 0.3 | N/A            | ps (rms) | 1,2,3,4   |
|                                    | t <sub>jph125M0</sub>      | 125MHz, 1.5MHz to 10MHz, -20dB/decade<br>rollover < 1.5MHz, -40db/decade rolloff > 10MHz |     | 200 | 300 | N/A            | fs (rms) | 1,6       |
|                                    | t <sub>jph125M1</sub>      | 125MHz, 12KHz to 20MHz, -20dB/decade<br>rollover < 1.5MHz, -40db/decade rolloff > 10MHz  |     | 313 | 350 | N/A            | fs (rms) | 1,6       |

<sup>1</sup> Guaranteed by design and characterization, not 100% tested in production.

<sup>2</sup> See <http://www.pcisig.com> for complete specs

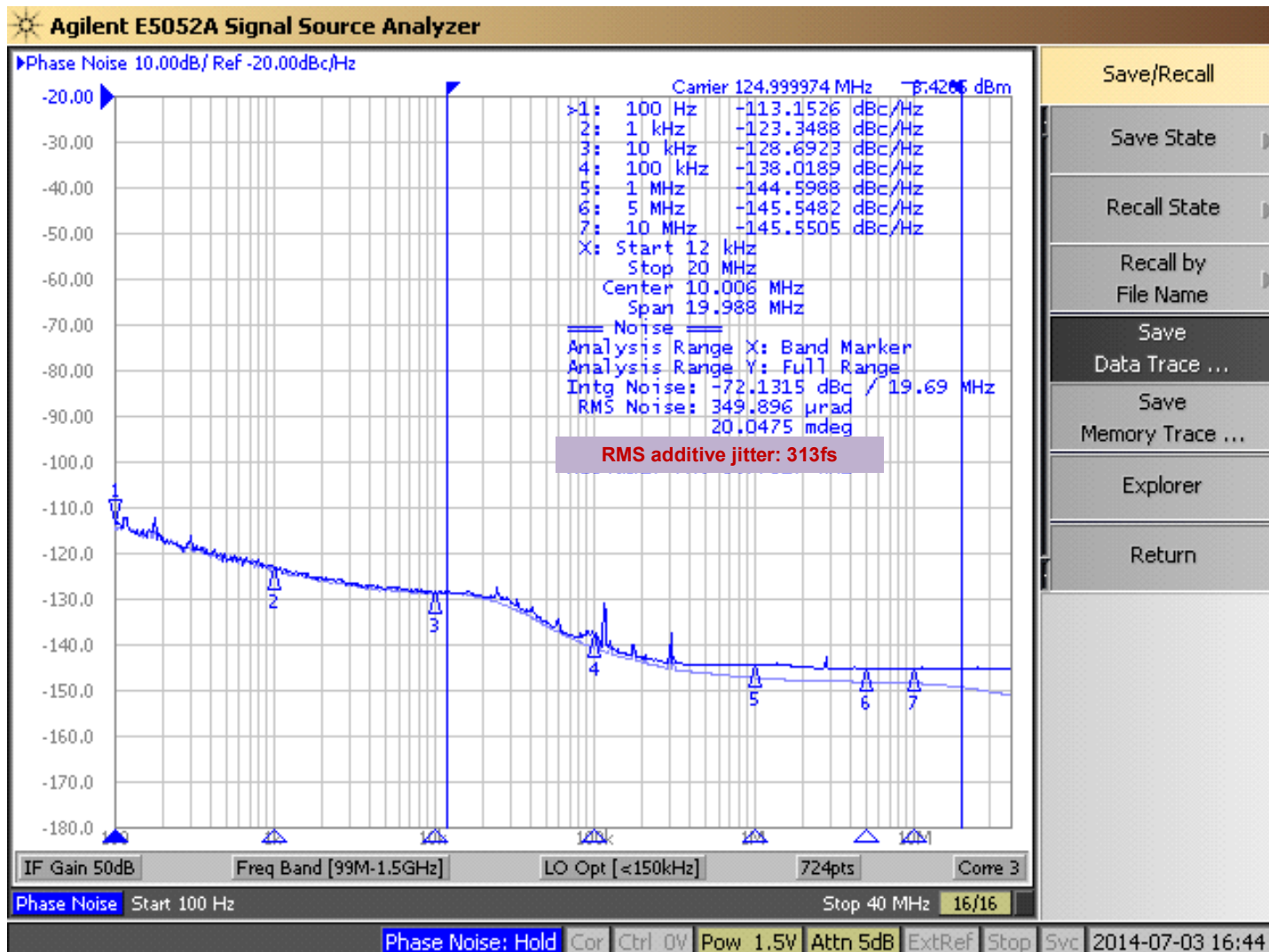
<sup>3</sup> Sample size of at least 100K cycles. This figures extrapolates to 108ps pk-pk @ 1M cycles for a BER of 1-12.

<sup>4</sup> For RMS figures, additive jitter is calculated by solving the following equation: Additive jitter = SQRT[(total jitter)<sup>2</sup> - (input jitter)<sup>2</sup>]

<sup>5</sup> Driven by 9FGU0831 or equivalent

<sup>6</sup> Rohde&Schartz SMA100

# Additive Phase Jitter Plot: 125M (12kHz to 20MHz)



## General SMBus Serial Interface Information

### How to Write

- Controller (host) sends a start bit
- Controller (host) sends the write address
- Renesas clock will **acknowledge**
- Controller (host) sends the beginning byte location = N
- Renesas clock will **acknowledge**
- Controller (host) sends the byte count = X
- Renesas clock will **acknowledge**
- Controller (host) starts sending Byte N through Byte N+X-1
- Renesas clock will **acknowledge** each byte **one at a time**
- Controller (host) sends a Stop bit

| Index Block Write Operation |           |                          |     |
|-----------------------------|-----------|--------------------------|-----|
| Controller (Host)           |           | Renesas (Slave/Receiver) |     |
| T                           | starT bit |                          |     |
| Slave Address               |           |                          |     |
| WR                          | WRite     |                          |     |
|                             |           |                          | ACK |
| Beginning Byte = N          |           |                          |     |
|                             |           |                          | ACK |
| Data Byte Count = X         |           |                          |     |
|                             |           |                          | ACK |
| Beginning Byte N            |           |                          |     |
|                             |           |                          | ACK |
| O                           |           | X Byte                   | O   |
| O                           |           |                          | O   |
| O                           |           |                          | O   |
|                             |           |                          |     |
| Byte N + X - 1              |           |                          |     |
|                             |           |                          | ACK |
| P                           | stoP bit  |                          |     |

*Note:* SMBus Address is Latched on SADR pin.

### How to Read

- Controller (host) will send a start bit
- Controller (host) sends the write address
- Renesas clock will **acknowledge**
- Controller (host) sends the beginning byte location = N
- Renesas clock will **acknowledge**
- Controller (host) will send a separate start bit
- Controller (host) sends the read address
- Renesas clock will **acknowledge**
- Renesas clock will send the data byte count = X
- Renesas clock sends Byte N+X-1
- Renesas clock sends **Byte 0 through Byte X (if X<sub>(H)</sub> was written to Byte 8)**
- Controller (host) will need to acknowledge each byte
- Controller (host) will send a not acknowledge bit
- Controller (host) will send a stop bit

| Index Block Read Operation |                 |         |                   |
|----------------------------|-----------------|---------|-------------------|
| Controller (Host)          |                 | Renesas |                   |
| T                          | starT bit       |         |                   |
| Slave Address              |                 |         |                   |
| WR                         | WRite           |         |                   |
|                            |                 |         | ACK               |
| Beginning Byte = N         |                 |         |                   |
|                            |                 |         | ACK               |
| RT                         | Repeat starT    |         |                   |
| Slave Address              |                 |         |                   |
| RD                         | ReaD            |         |                   |
|                            |                 |         | ACK               |
|                            |                 |         | Data Byte Count=X |
| ACK                        |                 |         |                   |
| ACK                        |                 |         | Beginning Byte N  |
|                            |                 | X Byte  | O                 |
| O                          |                 |         | O                 |
| O                          |                 |         | O                 |
| O                          |                 |         |                   |
|                            |                 |         | Byte N + X - 1    |
| N                          | Not acknowledge |         |                   |
| P                          | stoP bit        |         |                   |

**SMBus Table: Output Enable Register <sup>1</sup>**

| Byte 0 | Name     | Control Function | Type | 0       | 1       | Default |
|--------|----------|------------------|------|---------|---------|---------|
| Bit 7  | DIF OE5  | Output Enable    | RW   | Low/Low | Enabled | 1       |
| Bit 6  | DIF OE4  | Output Enable    | RW   | Low/Low | Enabled | 1       |
| Bit 5  | Reserved |                  |      |         |         | 1       |
| Bit 4  | DIF OE3  | Output Enable    | RW   | Low/Low | Enabled | 1       |
| Bit 3  | DIF OE2  | Output Enable    | RW   | Low/Low | Enabled | 1       |
| Bit 2  | DIF OE1  | Output Enable    | RW   | Low/Low | Enabled | 1       |
| Bit 1  | Reserved |                  |      |         |         | 1       |
| Bit 0  | DIF OE0  | Output Enable    | RW   | Low/Low | Enabled | 1       |

1. A low on these bits will override the OE# pin and force the differential output Low/Low

**SMBus Table: PLL Operating Mode and Output Amplitude Control Register**

| Byte 1 | Name            | Control Function               | Type            | 0                              | 1                              | Default |
|--------|-----------------|--------------------------------|-----------------|--------------------------------|--------------------------------|---------|
| Bit 7  | PLLMODERB1      | PLL Mode Readback Bit 1        | R               | See PLL Operating Mode Table   |                                | Latch   |
| Bit 6  | PLLMODERB0      | PLL Mode Readback Bit 0        | R               |                                |                                | Latch   |
| Bit 5  | PLLMODE_SWCNTRL | Enable SW control of PLL Mode: | RW              | Values in B1[7:6] set PLL Mode | Values in B1[4:3] set PLL Mode | 0       |
| Bit 4  | PLLMODE1        | PLL Mode Control Bit 1         | RW <sup>1</sup> | See PLL Operating Mode Table   |                                | 0       |
| Bit 3  | PLLMODE0        | PLL Mode Control Bit 0         | RW <sup>1</sup> |                                |                                | 0       |
| Bit 2  | Reserved        |                                |                 |                                |                                | 1       |
| Bit 1  | AMPLITUDE 1     | Controls Output Amplitude      | RW              | 00 = 0.55V                     | 01= 0.65V                      | 1       |
| Bit 0  | AMPLITUDE 0     |                                | RW              | 10 = 0.7V                      | 11 = 0.8V                      | 0       |

1. B1[5] must be set to a 1 for these bits to have any effect on the part.

**SMBus Table: DIF Slew Rate Control Register**

| Byte 2 | Name             | Control Function         | Type | 0            | 1            | Default |
|--------|------------------|--------------------------|------|--------------|--------------|---------|
| Bit 7  | SLEWRATESEL DIF5 | Adjust Slew Rate of DIF5 | RW   | Slow Setting | Fast Setting | 1       |
| Bit 6  | SLEWRATESEL DIF4 | Adjust Slew Rate of DIF4 | RW   | Slow Setting | Fast Setting | 1       |
| Bit 5  | Reserved         |                          |      |              |              | 1       |
| Bit 4  | SLEWRATESEL DIF3 | Adjust Slew Rate of DIF3 | RW   | Slow Setting | Fast Setting | 1       |
| Bit 3  | SLEWRATESEL DIF2 | Adjust Slew Rate of DIF2 | RW   | Slow Setting | Fast Setting | 1       |
| Bit 2  | SLEWRATESEL DIF1 | Adjust Slew Rate of DIF1 | RW   | Slow Setting | Fast Setting | 1       |
| Bit 1  | Reserved         |                          |      |              |              | 1       |
| Bit 0  | SLEWRATESEL DIF0 | Adjust Slew Rate of DIF0 | RW   | Slow Setting | Fast Setting | 1       |

Note: See "Low-Power HCSL Outputs" table for slew rates.

**SMBus Table: Frequency Select Control Register**

| Byte 3 | Name           | Control Function       | Type | 0            | 1            | Default |
|--------|----------------|------------------------|------|--------------|--------------|---------|
| Bit 7  | Reserved       |                        |      |              |              | 1       |
| Bit 6  | Reserved       |                        |      |              |              | 1       |
| Bit 5  | Reserved       |                        |      |              |              | 0       |
| Bit 4  | Reserved       |                        |      |              |              | 0       |
| Bit 3  | Reserved       |                        |      |              |              | 0       |
| Bit 2  | Reserved       |                        |      |              |              | 1       |
| Bit 1  | Reserved       |                        |      |              |              | 1       |
| Bit 0  | SLEWRATESEL FB | Adjust Slew Rate of FB | RW   | Slow Setting | Fast Setting | 1       |

Byte 4 is Reserved and reads back 'hFF'

**SMBus Table: Revision and Vendor ID Register**

| Byte 5 | Name | Control Function | Type | 0            | 1 | Default |
|--------|------|------------------|------|--------------|---|---------|
| Bit 7  | RID3 | Revision ID      | R    | A rev = 0000 |   | 0       |
| Bit 6  | RID2 |                  | R    |              |   | 0       |
| Bit 5  | RID1 |                  | R    |              |   | 0       |
| Bit 4  | RID0 |                  | R    |              |   | 0       |
| Bit 3  | VID3 | VENDOR ID        | R    | 0001 = IDT   |   | 0       |
| Bit 2  | VID2 |                  | R    |              |   | 0       |
| Bit 1  | VID1 |                  | R    |              |   | 0       |
| Bit 0  | VID0 |                  | R    |              |   | 1       |

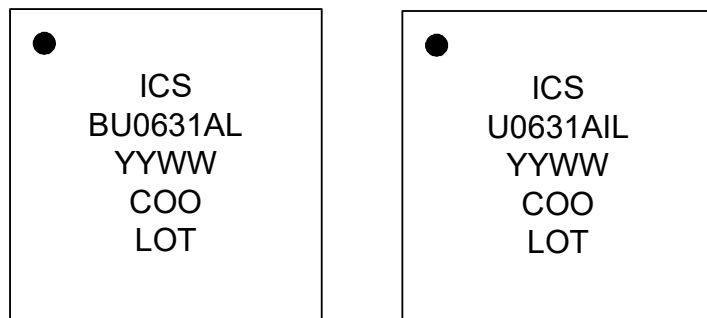
**SMBus Table: Device Type/Device ID**

| Byte 6 | Name         | Control Function | Type | 0                                                    | 1 | Default |
|--------|--------------|------------------|------|------------------------------------------------------|---|---------|
| Bit 7  | Device Type1 | Device Type      | R    | 00 = FGx, 01 = DBx ZDB/FOB,<br>10 = DMx, 11= DBx FOB |   | 0       |
| Bit 6  | Device Type0 |                  | R    |                                                      |   | 1       |
| Bit 5  | Device ID5   | Device ID        | R    | 000110 binary or 06 hex                              |   | 0       |
| Bit 4  | Device ID4   |                  | R    |                                                      |   | 0       |
| Bit 3  | Device ID3   |                  | R    |                                                      |   | 0       |
| Bit 2  | Device ID2   |                  | R    |                                                      |   | 1       |
| Bit 1  | Device ID1   |                  | R    |                                                      |   | 1       |
| Bit 0  | Device ID0   |                  | R    |                                                      |   | 0       |

**SMBus Table: Byte Count Register**

| Byte 7 | Name     | Control Function       | Type | 0                                                                                                     | 1 | Default |
|--------|----------|------------------------|------|-------------------------------------------------------------------------------------------------------|---|---------|
| Bit 7  | Reserved |                        |      |                                                                                                       |   | 0       |
| Bit 6  | Reserved |                        |      |                                                                                                       |   | 0       |
| Bit 5  | Reserved |                        |      |                                                                                                       |   | 0       |
| Bit 4  | BC4      | Byte Count Programming | RW   | Writing to this register will configure how<br>many bytes will be read back, default is<br>= 8 bytes. |   | 0       |
| Bit 3  | BC3      |                        | RW   |                                                                                                       |   | 1       |
| Bit 2  | BC2      |                        | RW   |                                                                                                       |   | 0       |
| Bit 1  | BC1      |                        | RW   |                                                                                                       |   | 0       |
| Bit 0  | BC0      |                        | RW   |                                                                                                       |   | 0       |

## Marking Diagrams



### Notes:

1. "LOT" is the lot sequence number.
2. "COO" denotes country of origin.
3. YYWW is the last two digits of the year and week that the part was assembled.
4. Line 2: truncated part number
5. "L" denotes RoHS compliant package.
6. "I" denotes industrial temperature range device.

## Thermal Characteristics

| PARAMETER          | SYMBOL         | CONDITIONS                      | PKG   | TYP<br>VALUE | UNITS | NOTES |
|--------------------|----------------|---------------------------------|-------|--------------|-------|-------|
| Thermal Resistance | $\theta_{JC}$  | Junction to Case                | NDG40 | 42           | °C/W  | 1     |
|                    | $\theta_{Jb}$  | Junction to Base                |       | 2.4          | °C/W  | 1     |
|                    | $\theta_{JA0}$ | Junction to Air, still air      |       | 39           | °C/W  | 1     |
|                    | $\theta_{JA1}$ | Junction to Air, 1 m/s air flow |       | 33           | °C/W  | 1     |
|                    | $\theta_{JA3}$ | Junction to Air, 3 m/s air flow |       | 28           | °C/W  | 1     |
|                    | $\theta_{JA5}$ | Junction to Air, 5 m/s air flow |       | 27           | °C/W  | 1     |

<sup>1</sup>ePad soldered to board

## Package Outline Drawings

The package outline drawings are located at the end of this document and are accessible from the Renesas website. The package information is the most current data available and is subject to change without revision of this document.

40-VFQFPN 5.0 x 5.0 x 0.9 mm Body, 0.4 mm Pitch

## Ordering Information

| Part / Order Number | Shipping Packaging | Package       | Temperature   |
|---------------------|--------------------|---------------|---------------|
| 9DBU0631AKLF        | Trays              | 40-pin VFQFPN | 0 to +70° C   |
| 9DBU0631AKLF        | Tape and Reel      | 40-pin VFQFPN | 0 to +70° C   |
| 9DBU0631AKILF       | Trays              | 40-pin VFQFPN | -40 to +85° C |
| 9DBU0631AKILF       | Tape and Reel      | 40-pin VFQFPN | -40 to +85° C |

"LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

"A" is the device revision designator (will not correlate with the datasheet revision).

## Revision History

| Revision Date | Description                                                                                                                                                                                                                                 |
|---------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 7/15/2014     | 1. Updated electrical tables with char data.<br>2. Added an additive phase jitter plot.<br>3. Added 12kHz to 20MHz <i>additive</i> phase jitter spec.<br>4. Updated Amplitude control bit <i>descriptions</i> in Byte 1.                    |
| 9/19/2014     | Updated SMBus Input High/Low parameters conditions, MAX values, and footnotes.                                                                                                                                                              |
| 4/22/2015     | 1. Updated pin out and pin descriptions to show ePad on package connected to ground.<br>2. Minor updates to front page text for family consistency.<br>3. Updated Clock Input Parameters table to be consistent with PCIe Vswing parameter. |
| 12/3/2025     | 1. Rebranded datasheet to Renesas.<br>2. Updated "Alternate Terminations" section.<br>3. Updated "Package Outline Drawings" section.                                                                                                        |



## IMPORTANT NOTICE AND DISCLAIMER

RENESAS ELECTRONICS CORPORATION AND ITS SUBSIDIARIES ("RENESAS") PROVIDES TECHNICAL SPECIFICATIONS AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS OR IMPLIED, INCLUDING, WITHOUT LIMITATION, ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT OF THIRD-PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for developers who are designing with Renesas products. You are solely responsible for (1) selecting the appropriate products for your application, (2) designing, validating, and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. Renesas grants you permission to use these resources only to develop an application that uses Renesas products. Other reproduction or use of these resources is strictly prohibited. No license is granted to any other Renesas intellectual property or to any third-party intellectual property. Renesas disclaims responsibility for, and you will fully indemnify Renesas and its representatives against, any claims, damages, costs, losses, or liabilities arising from your use of these resources. Renesas' products are provided only subject to Renesas' Terms and Conditions of Sale or other applicable terms agreed to in writing. No use of any Renesas resources expands or otherwise alters any applicable warranties or warranty disclaimers for these products.

(Disclaimer Rev.1.01)

### Corporate Headquarters

TOYOSU FORESIA, 3-2-24 Toyosu,  
Koto-ku, Tokyo 135-0061, Japan  
[www.renesas.com](http://www.renesas.com)

### Contact Information

For further information on a product, technology, the most up-to-date version of a document, or your nearest sales office, please visit [www.renesas.com/contact-us/](http://www.renesas.com/contact-us/).

### Trademarks

Renesas and the Renesas logo are trademarks of Renesas Electronics Corporation. All trademarks and registered trademarks are the property of their respective owners.